

Memory Module Specifications

R&D | OEM | ODM SSD & DDRAM

ST16D3P15S802G

SemiTank S8 2GB DDR3 1600 U-DIMM

DESCRIPTION

This document describes DDR3 240 Pin U-DIMM Non-ECC, P/N: ST16D3P15S802G. This Memory Module based on Capacity 2GB, Frequency 1600 Mhz, Latency CL11, Data Transfer Bandwidth 12.800 MB/s. DDR3 240 Pin U-DIMM Non-ECC uses gold contact fingers and used for:

- * Desktop.
- * All in One Computer.
- * Industrial Computer.
- * Mini Computer.

The electrical and mechanical specifications are as follows:

Feature

- Increased Fundamental Frequency, Faster Speeds.
- Unleashed Capacity, Stronger, Multitasking.
- Improved Structural Composition, Greater Efficiency.
- Reduced Working Voltage. Better Energy Efficiency.
- RoHS Compliant and Halogen-Free.

SPECIFICATIONS

| Module type | DDR3 240 Pin U-DIMM Non-ECC |
|-------------------------------|-----------------------------|
| Product Dimensions | 133.35*18.75*3.37 mm |
| Series | S8 Series |
| Frequency | 1600 Mhz |
| Latency | CL11 |
| Data Transfer Bandwidth | PC3 12800 12.800 MB/s |
| | |
| Capacity | 2GB |
| Capacity Voltage | 2GB 1.5V |
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| Voltage | 1.5V |
| Voltage Operating Temperature | 1.5V 0° C to +70° C |



*Note:

- We reserve the right to modify product specifications without prior notice.
- Check "Product Compatibility Inquiry" before purchase for further info.